

STP20NF06 STF20NF06

N-channel 60V - 0.06Ω - 20A - TO-220/TO-220FP STripFET™ II Power MOSFET

Features

Туре	V _{DSS}	R _{DS(on)}	I _D
STP20NF06	60V	<0.07Ω	20A
STF20NF06	60V	<0.07Ω	20A ⁽¹⁾

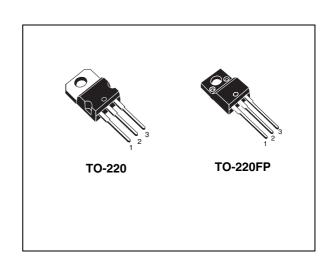
- Refer to soa for the max allowable current value on FP-type due to Rth value
- Avalanche rugged technology
- 100% avalanche tested
- 175°C operating temperature
- High dv/dt capability
- Application oriented characterization



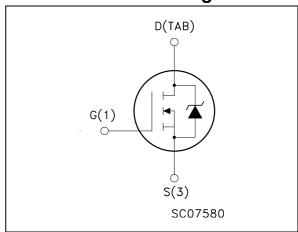
This Power MOSFET is the latest development of STMicroelectronics unique "Single Feature Size™" strip-based process. The resulting transistor shows extremely high packing density for low on-resistance, rugged avalanche characteristics and less critical alignment steps therefore a remarkable manufacturing reproducibility.

Application

Switching applications



Internal schematic diagram



Order codes

Part number	Marking	Package	Packaging
STP20NF06	P20NF06	TO-220	Tube
STF20NF06	F20NF06 F20NF06 TO-220FP		Tube

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2	Electrical characteristics
	2.1 Electrical characteristics (curves)
3	Test circuit
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STP20NF06 - STF20NF06 Electrical ratings

1 Electrical ratings

Table 1. Absolute maximum ratings

Cumbal	Dovometov	Va	Unit		
Symbol	Parameter	TO-220	TO-220FP	Oill	
V _{DS}	Drain-source voltage (V _{GS} = 0)	6	60	V	
V _{GS}	Gate- source voltage	±	20	V	
I _D	Drain current (continuous) at T _C = 25°C	20	20 ⁽¹⁾	Α	
I _D	Drain current (continuous) at T _C = 100°C	14	14 ⁽¹⁾	Α	
I _{DM} ⁽²⁾	Drain current (pulsed)	80	80 ⁽¹⁾	Α	
P _{tot}	Total dissipation at $T_C = 25^{\circ}C$ 60 28				
	Derating factor 0.4 0.18				
dv/dt (3)	Peak diode recovery voltage slope	,	V/ns		
E _{AS} (4)	Single pulse avalanche energy	1:	mJ		
V _{ISO}	Insulation withstand voltage (RMS) from all three leads to external heat sink (t=1s;T _C =25°C)	2500	V		
T _{stg}	Storage temperature -55 to 175				
T _j	Max. operating junction temperature	-55 (ပ္	

^{1.} Refer to SOA for the max allowable current value on FP-type due to Rth value

Table 2. Thermal data

Symbol	Parameter	TO-220	TO-220FP	Unit
Rthj-case	Thermal resistance junction-case max	2.5	°C/W	
Rthj-amb	Thermal resistance junction-ambient max	62	°C/W	
TJ	Maximum lead temperature for soldering purpose	30	°C	

^{2.} Pulse width limited by safe operating area.

^{3.} $I_{SD} \leq 20A$, $di/dt \leq 200A/\mu s$, $V_{DD} \leq V_{(BR)DSS}$, $Tj \leq T_{JMAX}$

^{4.} Starting $T_j = 25$ °C, $I_D = 10A$, $V_{DD} = 30V$

2 Electrical characteristics

(T_{CASE}=25°C unless otherwise specified)

Table 3. On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$I_D = 250 \mu A, V_{GS} = 0$	60			V
I _{DSS}	Zero gate voltage drain current (V _{GS} = 0)	V_{DS} = max ratings V_{DS} = max ratings, T_{C} = 125°C			1 10	μ Α μ Α
I _{GSS}	Gate-body leakage current (V _{DS} = 0)	V _{GS} = ± 20V			±100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2	3	4	٧
R _{DS(on)}	Static drain-source on resistance	V _{GS} = 10V, I _D = 10A		0.06	0.07	Ω

Table 4. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
9 _{fs} ⁽¹⁾	Forward transconductance	V _{DS} = 15V, I _D = 8A		10		S
C _{iss} C _{oss} C _{rss}	Input capacitance Output capacitance Reverse transfer capacitance	$V_{DS} = 25V, f = 1MHz,$ $V_{GS} = 0$		400 100 40		pF pF pF
t _{d(on)} t _r t _{d(off)} t _f	Turn-on delay time Rise time Turn-off delay time Fall time	V_{DD} = 30V, I_{D} = 10A R_{G} = 4.7 Ω V_{GS} = 10V (see <i>Figure 15</i>)		5 15 15 5		ns ns ns
Q _g Q _{gs} Q _{gd}	Total gate charge Gate-source charge Gate-drain charge	$V_{DD} = 30V$, $I_D = 20A$, $V_{GS} = 10V$ (see Figure 16)		14 3 5.5	18	nC nC nC

^{1.} Pulsed: Pulse duration = 300 μ s, duty cycle 1.5%.

Table 5. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current Source-drain current (pulsed)				20 80	A A
V _{SD} ⁽²⁾	Forward on voltage	I _{SD} = 20A, V _{GS} = 0			1.5	V
t _{rr} Q _{rr} I _{RRM}	Reverse recovery time Reverse recovery charge Reverse recovery current	I_{SD} = 20A, di/dt = 100A/ μ s, V_{DD} = 20V, T_j = 150°C (see <i>Figure 17</i>)		50 88 3.2		ns nC A

^{1.} Pulse width limited by safe operating area.

^{2.} Pulsed: Pulse duration = 300 μ s, duty cycle 1.5%

2.1 Electrical characteristics (curves)

Figure 1. Safe operating area for TO-220

Figure 2. Thermal impedance for TO-220

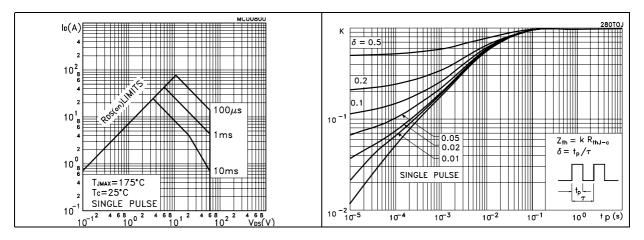


Figure 3. Safe operating area for TO-220FP

Figure 4. Thermal impedance for TO-220FP

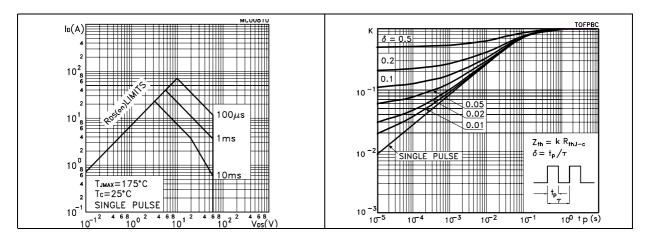
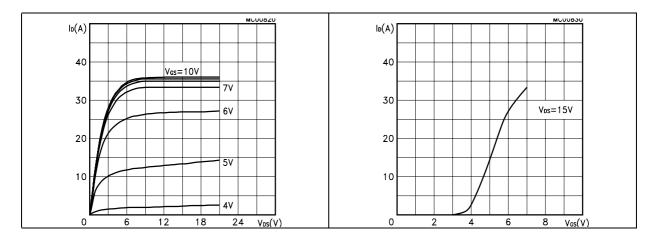


Figure 5. Output characteristics

Figure 6. Transfer characteristics



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Figure 7. Transconductance

Figure 8. Static drain-source on resistance

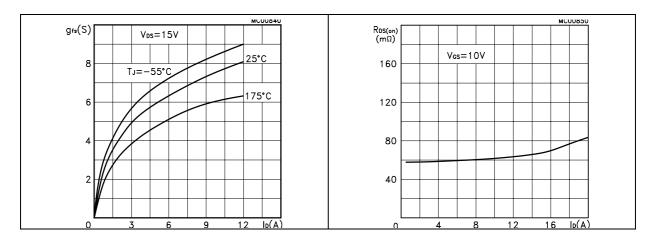


Figure 9. Gate charge vs. gate-source voltage Figure 10. Capacitance variations

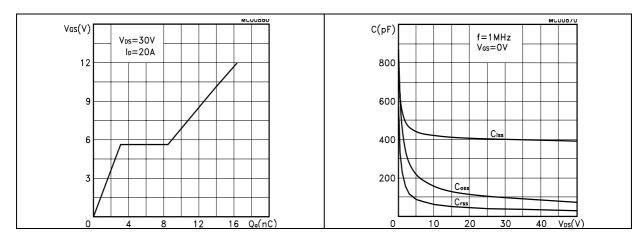


Figure 11. Normalized gate threshold voltage Figure 12. Normalized on resistance vs. vs. temperature temperature

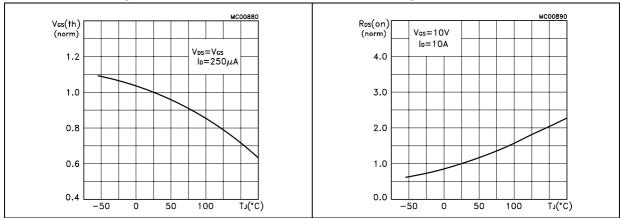
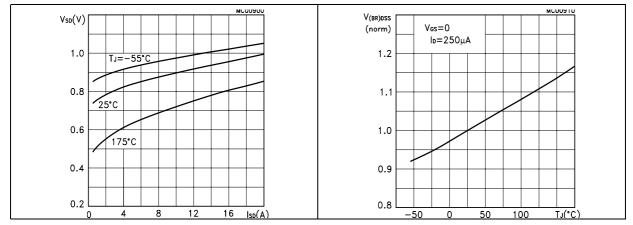


Figure 13. Source-drain diode forward characteristics

Figure 14. Normalized $\ensuremath{B_{\text{VDSS}}}$ vs. temperature



3 Test circuit

Figure 15. Switching times test circuit for resistive load

Figure 16. Gate charge test circuit

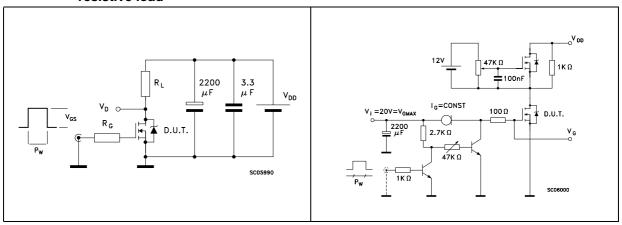


Figure 17. Test circuit for inductive load switching and diode recovery times

Figure 18. Unclamped Inductive load test circuit

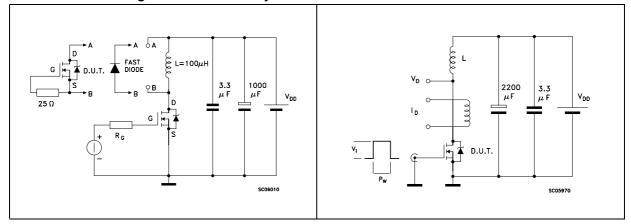
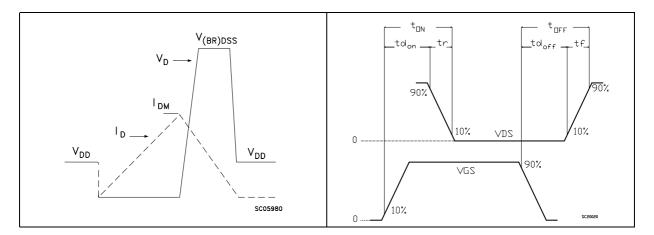


Figure 19. Unclamped inductive waveform

Figure 20. Switching time waveform



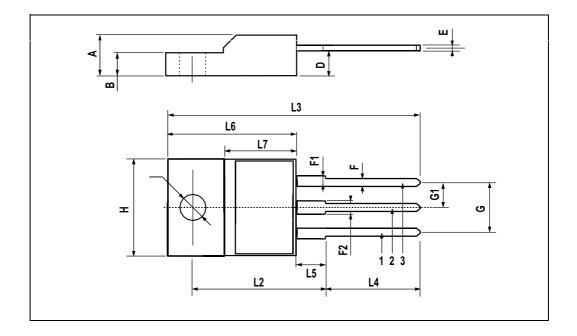
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4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

TO-220FP MECHANICAL DATA

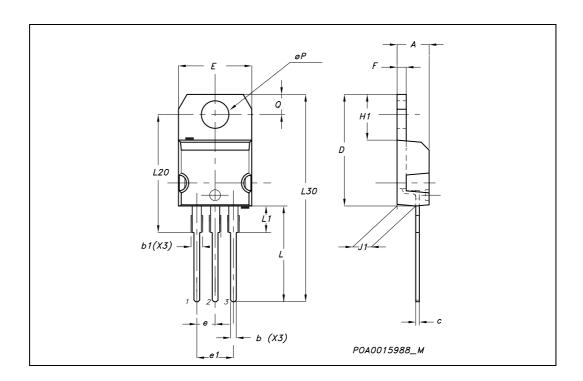
DIM	mm.			inch		
DIM.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
Α	4.4		4.6	0.173		0.181
В	2.5		2.7	0.098		0.106
D	2.5		2.75	0.098		0.108
Е	0.45		0.7	0.017		0.027
F	0.75		1	0.030		0.039
F1	1.15		1.7	0.045		0.067
F2	1.15		1.7	0.045		0.067
G	4.95		5.2	0.195		0.204
G1	2.4		2.7	0.094		0.106
Н	10		10.4	0.393		0.409
L2		16			0.630	
L3	28.6		30.6	1.126		1.204
L4	9.8		10.6	.0385		0.417
L5	2.9		3.6	0.114		0.141
L6	15.9		16.4	0.626		0.645
L7	9		9.3	0.354		0.366
Ø	3		3.2	0.118		0.126



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TO-220 MECHANICAL DATA

DIM.		mm.			inch	,	
DIW.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.	
Α	4.40		4.60	0.173		0.181	
b	0.61		0.88	0.024		0.034	
b1	1.15		1.70	0.045		0.066	
С	0.49		0.70	0.019		0.027	
D	15.25		15.75	0.60		0.620	
E	10		10.40	0.393		0.409	
е	2.40		2.70	0.094		0.106	
e1	4.95		5.15	0.194		0.202	
F	1.23		1.32	0.048		0.052	
H1	6.20		6.60	0.244		0.256	
J1	2.40		2.72	0.094		0.107	
L	13		14	0.511		0.551	
L1	3.50		3.93	0.137		0.154	
L20		16.40			0.645		
L30		28.90			1.137		
øΡ	3.75		3.85	0.147		0.151	
Q	2.65		2.95	0.104		0.116	



STP20NF06 - STF20NF06 Revision history

5 Revision history

Table 6. Revision history

Date	Revision	Changes
07-Dec-2004	1	First version
09-Aug-2006	2	The document has been reformatted
30-May-2007	3	Modified part number

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